



Micro Commercial Components 20736 Marilla Street Chatsworth

CA 91311

Phone: (818) 701-4933 Fax: (818) 701-4939 **SI2301**

Features

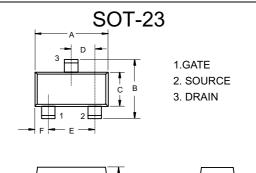
- Halogen free available upon request by adding suffix "-HF"
- -20V,-2.8A, $R_{DS(ON)}$ =120m Ω @ V_{GS} =-4.5V $R_{DS(ON)}$ =150m Ω @V_{GS}=-2.5V
- High dense cell design for extremely low R_{DS(ON)}
- Rugged and reliable
- High Speed Switching
- SOT-23 Package
- Marking Code: S1
- Epoxy meets UL 94 V-0 flammability rating

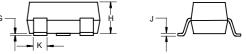
Moisture Sensitivity Level 1

Maximum Ratings @ 25°C Unless Otherwise Specified

Symbol	Parameter	Rating	Unit	
V_{DS}	Drain-source Voltage	-20	V	
I _D	Drain Current-Continuous	-2.8	Α	
I _{DM}	Drain Current-Pulsed ^a	-10	Α	
V_{GS}	Gate-source Voltage	±8	V	
P_{D}	Total Power Dissipation	1.25	W	
R _{⊕JA}	Thermal Resistance Junction to Ambient ^b	100	°C/W	
T_J	Operating Junction Temperature	-55 to +150	$^{\circ}\!\mathbb{C}$	
T _{STG}	Storage Temperature	-55 to +150	°C	

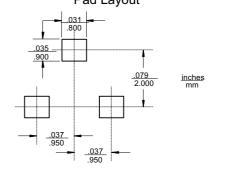
P-Channel Enhancement Mode Field Effect Transistor



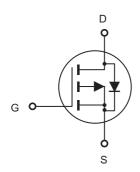


DIMENSIONS					
	INCHES		MM		
DIM	MIN	MAX	MIN	MAX	NOTE
Α	.110	.120	2.80	3.04	
В	.083	.104	2.10	2.64	
C	.047	.055	1.20	1.40	
D	.035	.041	.89	1.03	
Е	.070	.081	1.78	2.05	
F	.018	.024	.45	.60	
G	.0005	.0039	.013	.100	
Н	.035	.044	.89	1.12	
J	.003	.007	.085	.180	
K	.015	.020	.37	.51	

Suggested Solder Pad Layout



Internal Block Diagram





SI2301

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Off Characteristics						•
Drain-Source Breakdown Voltage	BV _{DSS}	$V_{GS} = 0V, I_{D} = -250\mu A$	-20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20V, V _{GS} = 0V			-1	μA
Gate Body Leakage Current, Forward	I _{GSSF}	$V_{GS} = 8V, V_{DS} = 0V$			100	nA
Gate Body Leakage Current, Reverse	Igssr	V_{GS} = -8V, V_{DS} = 0V			-100	nA
On Characteristics °						
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-0.45			V
Static Drain-Source		$V_{GS} = -4.5V, I_{D} = -2.8A$		80	120	mΩ
On-Resistance	R _{DS(on)}	$V_{GS} = -2.5V, I_{D} = -2.0A$		110	150	mΩ
Forward Transconductance	9 _{FS}	$V_{DS} = -5V, I_{D} = -2.8A$		8		S
Dynamic Characteristics d					•	
Input Capacitance	C _{iss}			880		pF
Output Capacitance	C _{oss}	$V_{DS} = -6V, V_{GS} = 0V,$ f = 1.0 MHz		270		pF
Reverse Transfer Capacitance	C _{rss}	1		175		pF
Switching Characteristics d						
Turn-On Delay Time	t _{d(on)}			11	20	ns
Turn-On Rise Time	t _r	$V_{DD} = -6V, I_{D} = -1A,$		5	10	ns
Turn-Off Delay Time	t _{d(off)}	$V_{GS} = -4.5V$, $R_{GEN} = 6\Omega$		32	65	ns
Turn-Off Fall Time	t _f			23	45	ns
Total Gate Charge	Q_g $V_{DS} = -6V, I_D = -2.8A,$ $V_{GS} = -4.5V$			11	14.5	nC
Gate-Source Charge				1.5		nC
Gate-Drain Charge	Q_{gd}	1.65		2.1		nC
Drain-Source Diode Characteristics and Maximun Ratings						
Drain-Source Diode Forward Current ^b	I _S				-0.75	А
Drain-Source Diode Forward Voltage °	V _{SD}	$V_{GS} = 0V, I_{S} = -0.75A$			-1.2	V

Notes:
a.Repetitive Rating: Pulse width limited by maximum junction temperature.b.Surface Mounted on FR4 Board, t < 5 sec.
c.Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
d.Guaranteed by design, not subject to production testing.



SI2301

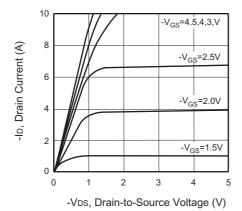


Figure 1. Output Characteristics

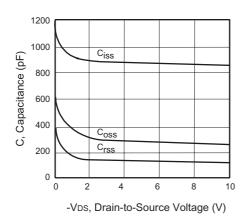


Figure 3. Capacitance

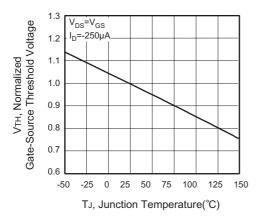


Figure 5. Gate Threshold Variation with Temperature

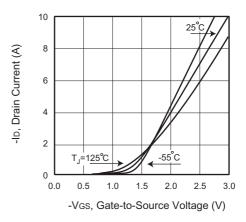


Figure 2. Transfer Characteristics

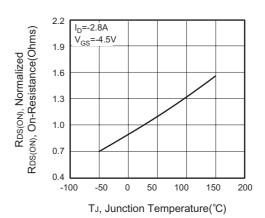


Figure 4. On-Resistance Variation with Temperature

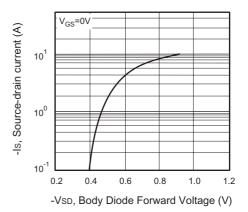


Figure 6. Body Diode Forward Voltage Variation with Source Current



SI2301

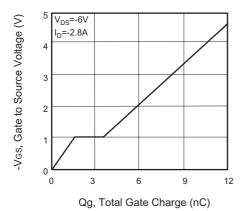


Figure 7. Gate Charge

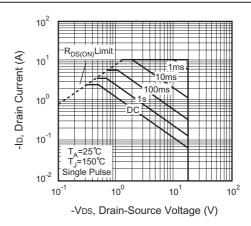


Figure 8. Maximum Safe Operating Area

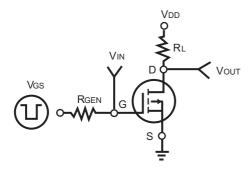


Figure 9. Switching Test Circuit

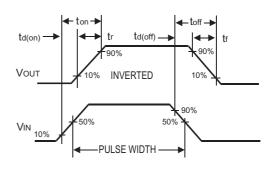


Figure 10. Switching Waveforms

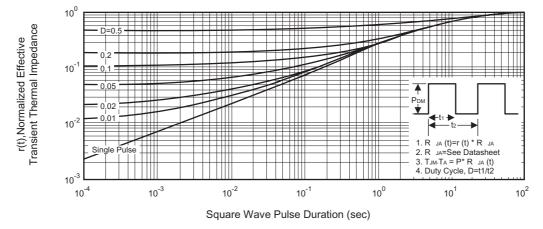


Figure 11. Normalized Thermal Transient Impedance Curve



Ordering Information:

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel

Note: Adding "-HF" suffix for halogen free, eg. Part Number-TP-HF

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